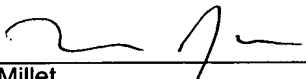
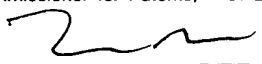




AMENDMENT TRANSMITTAL LETTER				Docket No. TESSERA 3.0-139 DIV	
Application No. 09/854,269		Filing Date May 11, 2001		Examiner M. Lewis	
Art Unit 2822					
Applicant(s): Thomas H. DiStefano					
Invention: MICROELECTRONIC PACKAGES WITH ELONGATED SOLDER INTERCONNECTIONS					
<b>TO THE COMMISSIONER FOR PATENTS</b>					
Transmitted herewith is an amendment in the above-identified application. The fee has been calculated and is transmitted as shown below.					
<b>CLAIMS AS AMENDED</b>					
	Claims Remaining After Amendment	Highest Number Previously Paid	Number Extra Claims Present	Rate	
Total Claims	9	- 20 =		x	0.00
Independent Claims	2	- 3 =		x	0.00
Multiple Dependent Claims (check if applicable) <input type="checkbox"/>					
Other fee (please specify): Extension for response within third month					
<b>TOTAL ADDITIONAL FEE FOR THIS AMENDMENT:</b>					
<input checked="" type="checkbox"/> Large Entity <input type="checkbox"/> Small Entity					
<input checked="" type="checkbox"/> No additional fee is required for this amendment.					
<input type="checkbox"/> Please charge Deposit Account No. _____ in the amount of \$ _____ A duplicate copy of this sheet is enclosed.					
<input type="checkbox"/> A check in the amount of \$ _____ to cover the filing fee is enclosed.					
<input type="checkbox"/> Payment by credit card. Form PTO-2038 is attached.					
<input checked="" type="checkbox"/> The Director is hereby authorized to charge and credit Deposit Account No. <u>12-1095</u> as described below. A duplicate copy of this sheet is enclosed.					
<input checked="" type="checkbox"/> Credit any overpayment.					
<input checked="" type="checkbox"/> Charge any additional filing or application processing fees required under 37 CFR 1.16 and 1.17.					
 Marcus J. Millet Attorney Reg. No.: 28,241				Dated: <u>July 29, 2003</u>	
LERNER, DAVID, LITTENBERG, KRUMHOLZ & MENTLIK, LLP 600 South Avenue West Westfield, New Jersey 07090 (908) 654-5000					
I hereby certify that this correspondence is being deposited with the U.S. Postal Service with sufficient postage as First Class Mail, in an envelope addressed to: MS RCE, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on the date shown below.					
Dated: July 29, 2003		Signature:  (Marcus J. Millet)			

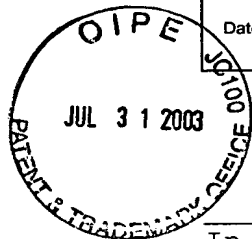
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Dated: July 29, 2003

Signature: [Signature]  
(Marcus J. Millet)



#9/B  
DKing  
8-12-03

Group Art Unit: 2822

Docket No.: TESSERA 3.0-139 DIV

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:  
Thomas H. DiStefano

Application No.: 09/854,269

Filed: May 11, 2001

For: MICROELECTRONIC PACKAGES WITH  
ELONGATED SOLDER INTERCONNECTIONS

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: Group Art Unit: 2822  
:  
: Examiner: M. Lewis  
:  
:  
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AMENDMENT

MS RCE  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

In response to the Official Action dated January 31, 2003, finally rejecting claims 1-7, please amend the above-identified U.S. patent application as follows:

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